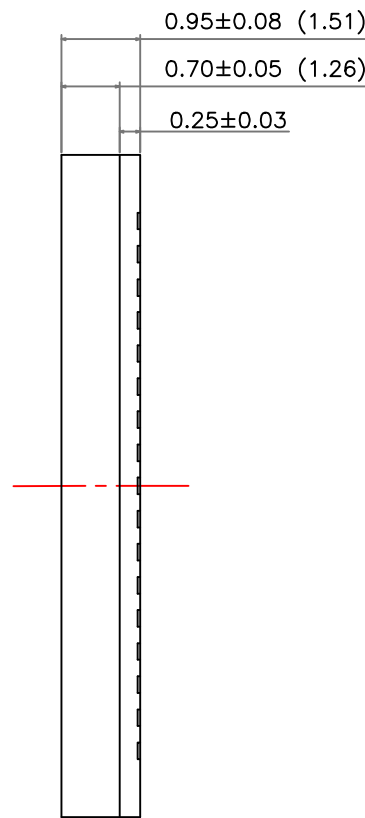
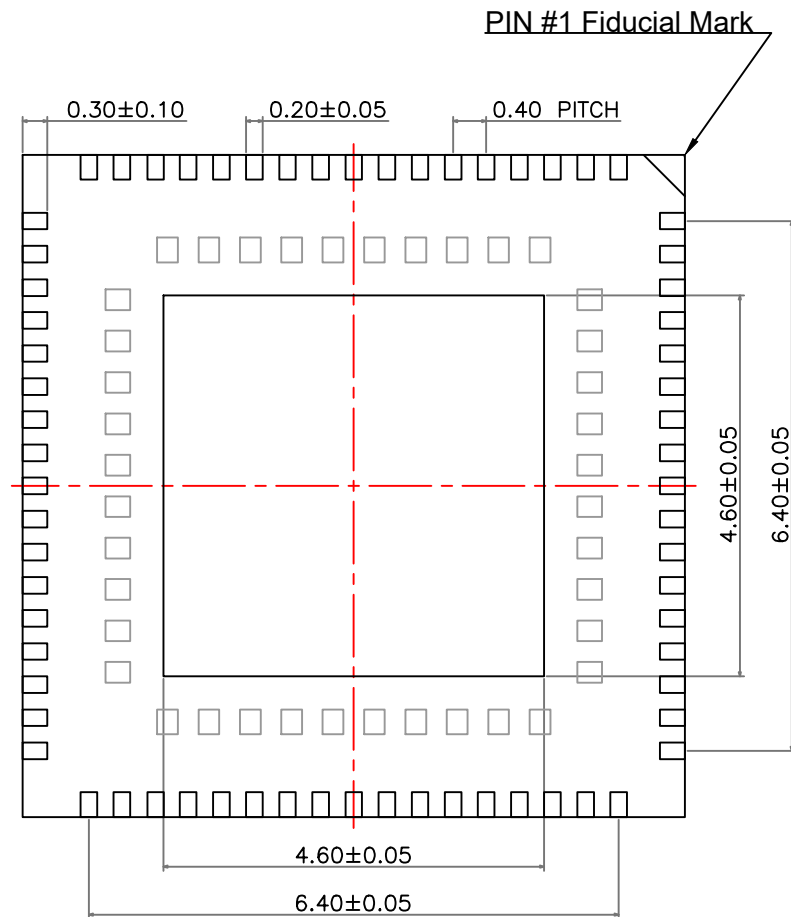


TOP VIEW



SIDE VIEW



BOTTOM VIEW

NOTES :

1. DRAWING CONFORM TO JEDEC
2. ALL DIMENSIONS ARE IN MILLIMETERS
3. SOLDERABLE EXPOSED PAD : 4.60 X 4.60 MM
4. DIMENSIONING AND TOLERANCING PER JEDEC
5. DIVERSIFICATION OF THE PKG OUTLINE IS POSSIBLE AS A LAND RADIAL TYPE

DESIGNED BY	CHECKED BY	CHECK BY	APPROVED BY	TITLE		
K.S.YUN				PKG OUTLINE DIMENSION MLQFN 68LD 8x8mm		
10/01/2023				UNIT	TOLERANCE	SCALE
SNPT (Semiconductor And Packaging Testing Corporation)				MM	-	1:1
				DWG NO.	SPEC NO.	SHEET
				POD-MLQFN-0868	MLQFN-02	1 OF 1